

STM32H7B3I-EVAL

MB1331

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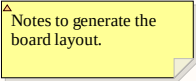
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Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.



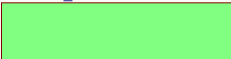
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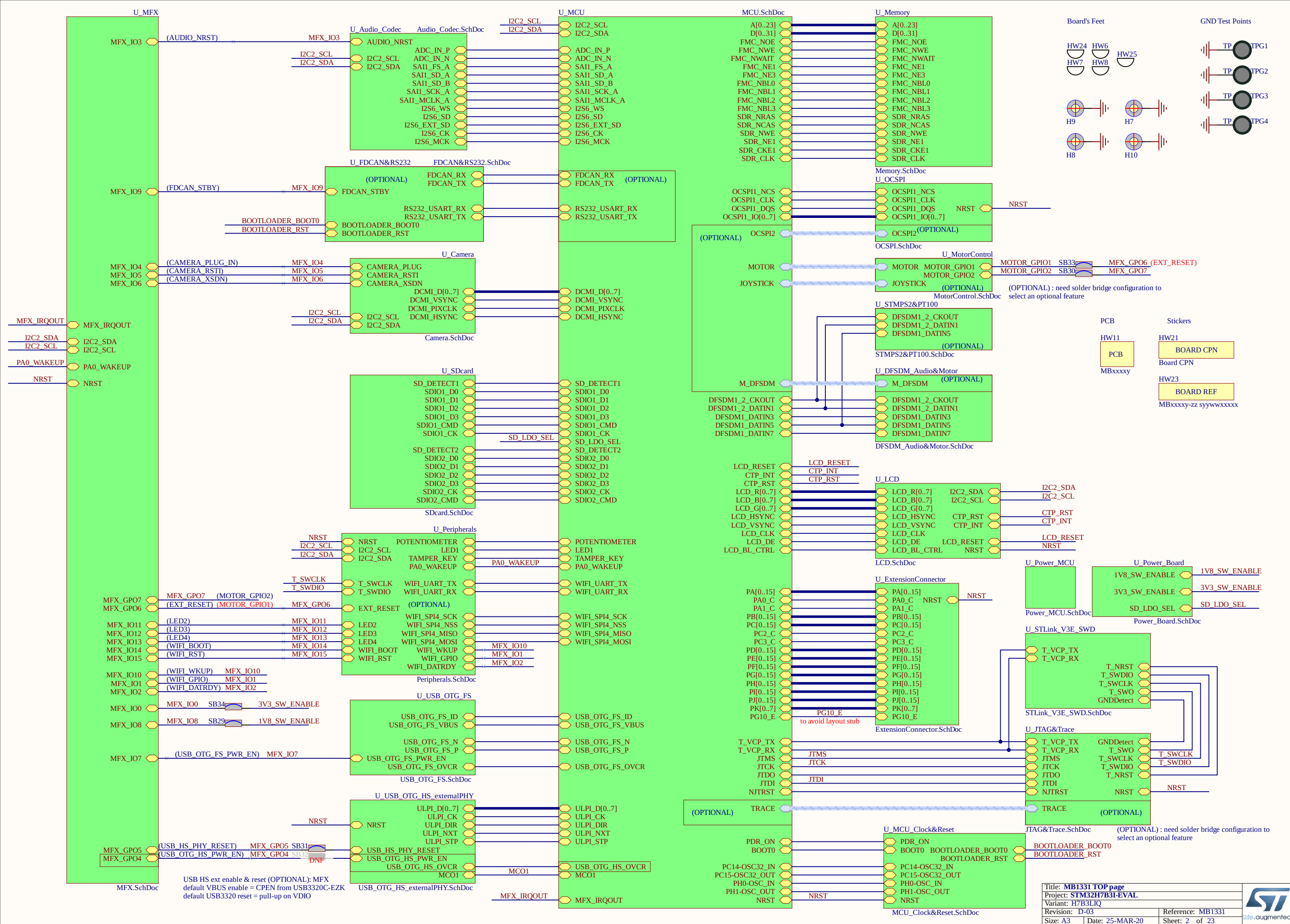
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U_Top
MB1331_TOP.SchDoc

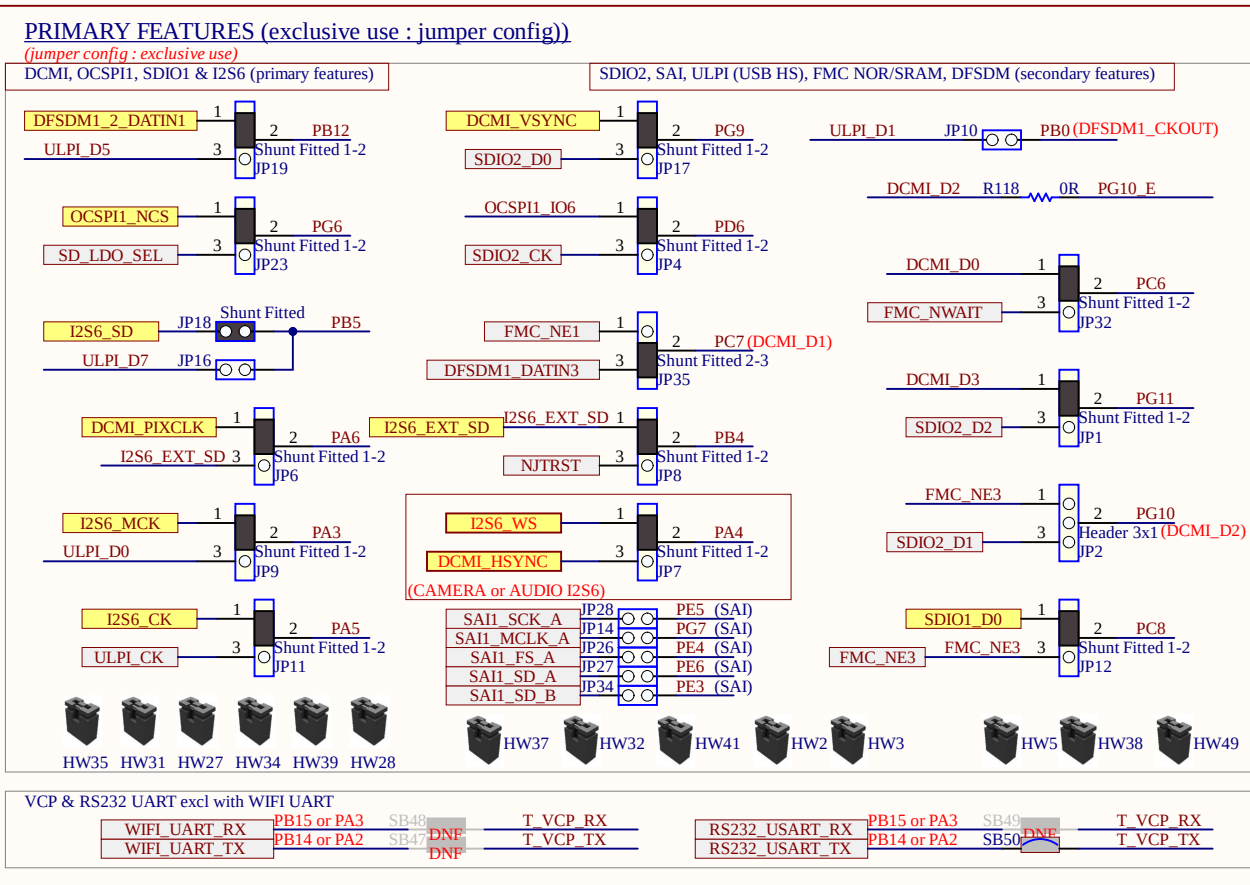
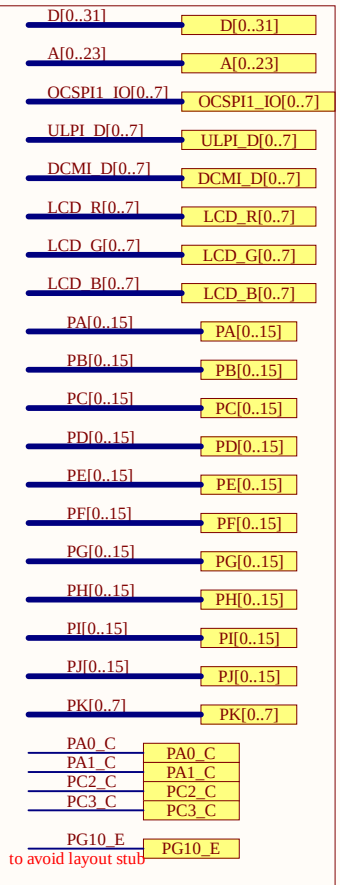
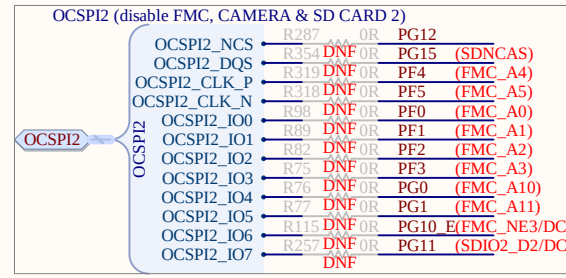
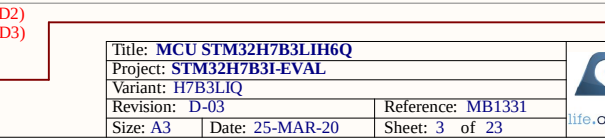
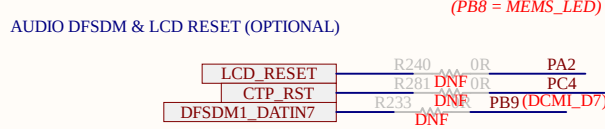
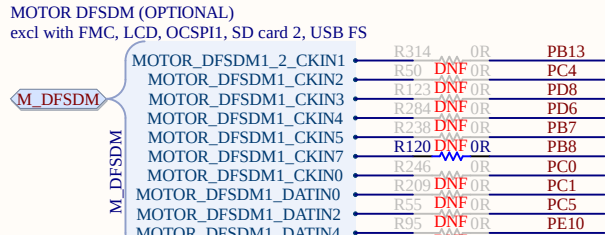
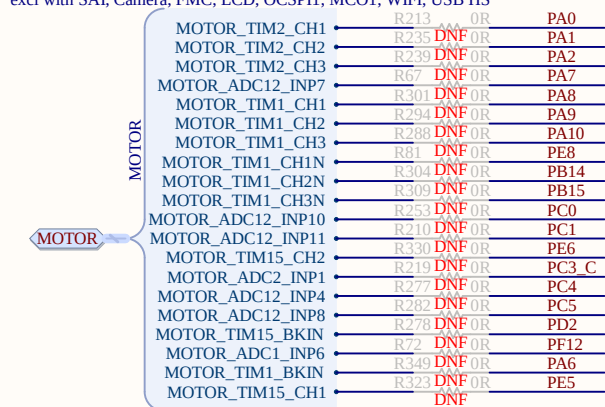
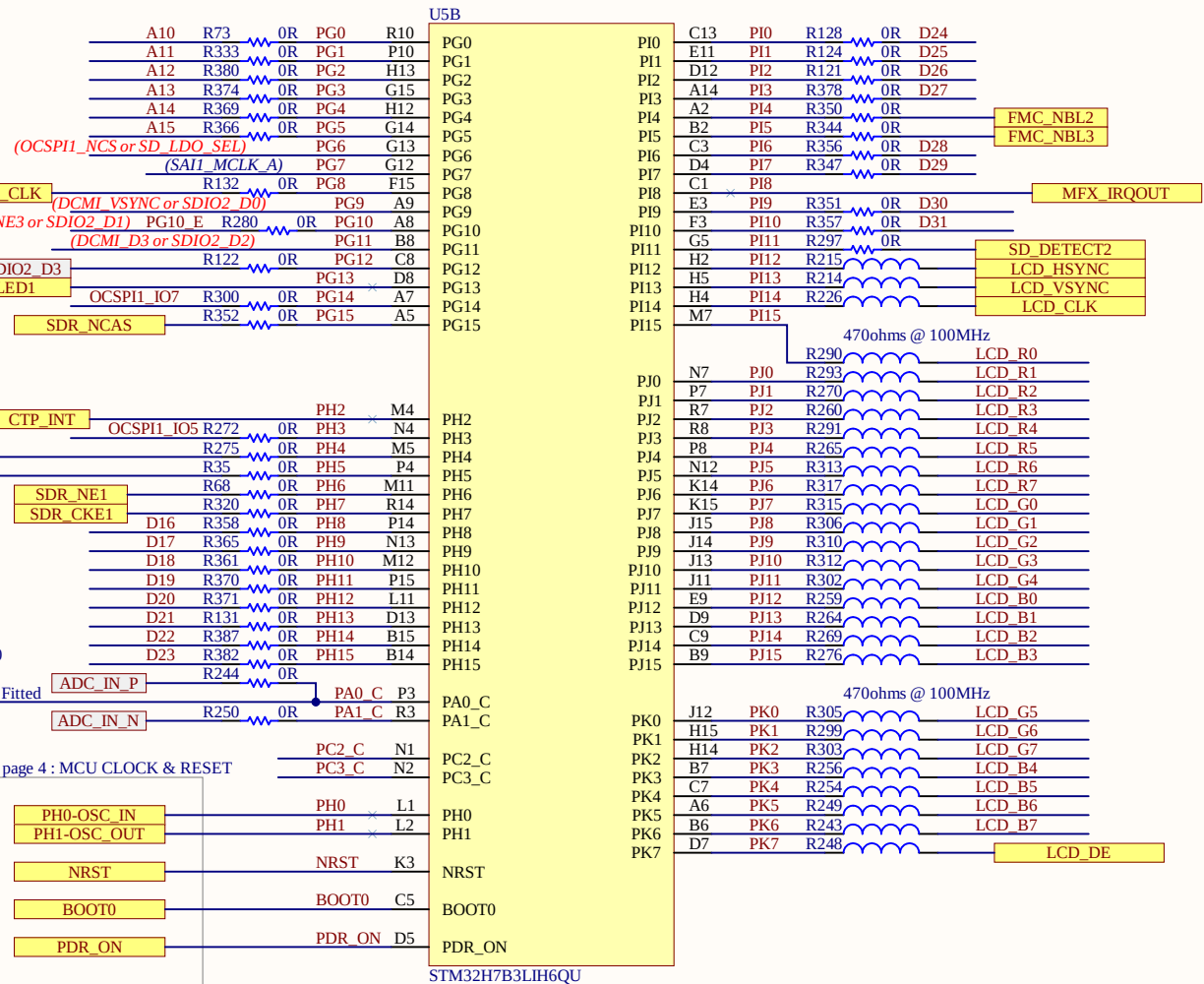


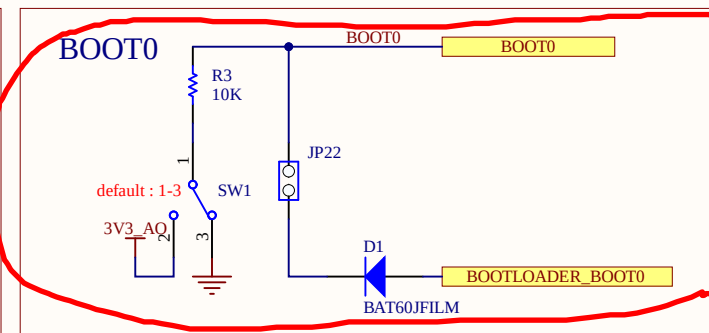
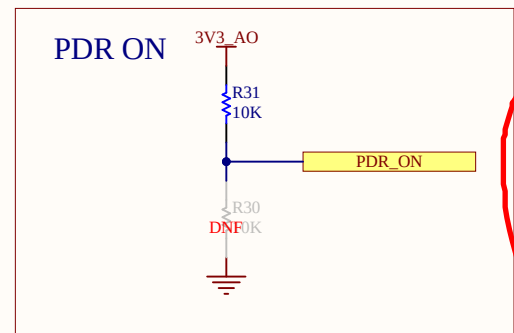
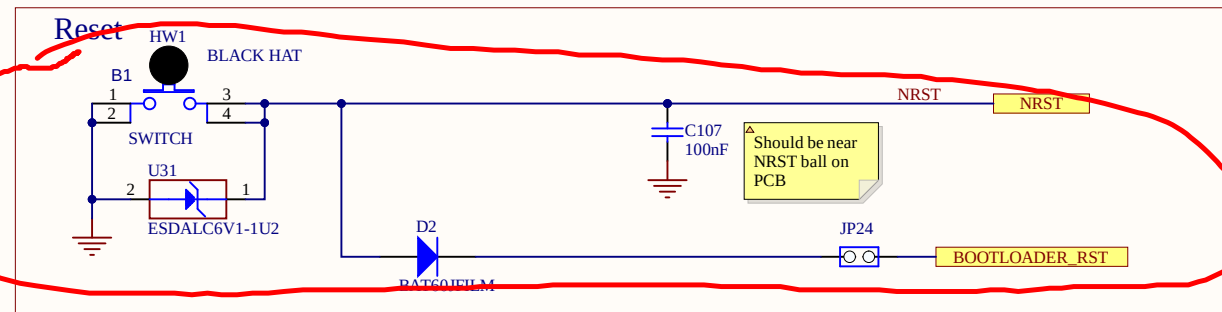
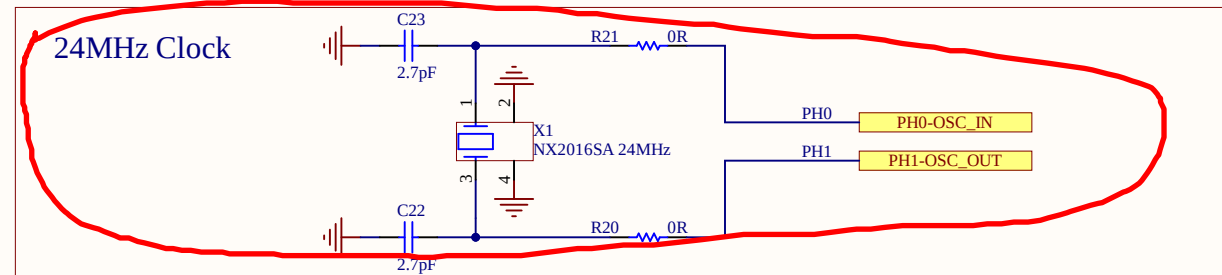
Title: Project overview		
Project: STM32H7B3I-EVAL		
Variant: H7B3LIQ		
Revision: D-03	Reference: MB1331	
Size: A4	Date: 25-MAR-20	Sheet: 1 of 23



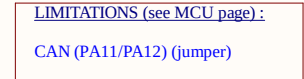


PRIMARY FEATURES (fitted by default)

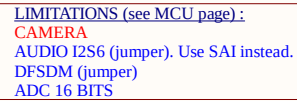




(Always $\overline{ON}$)



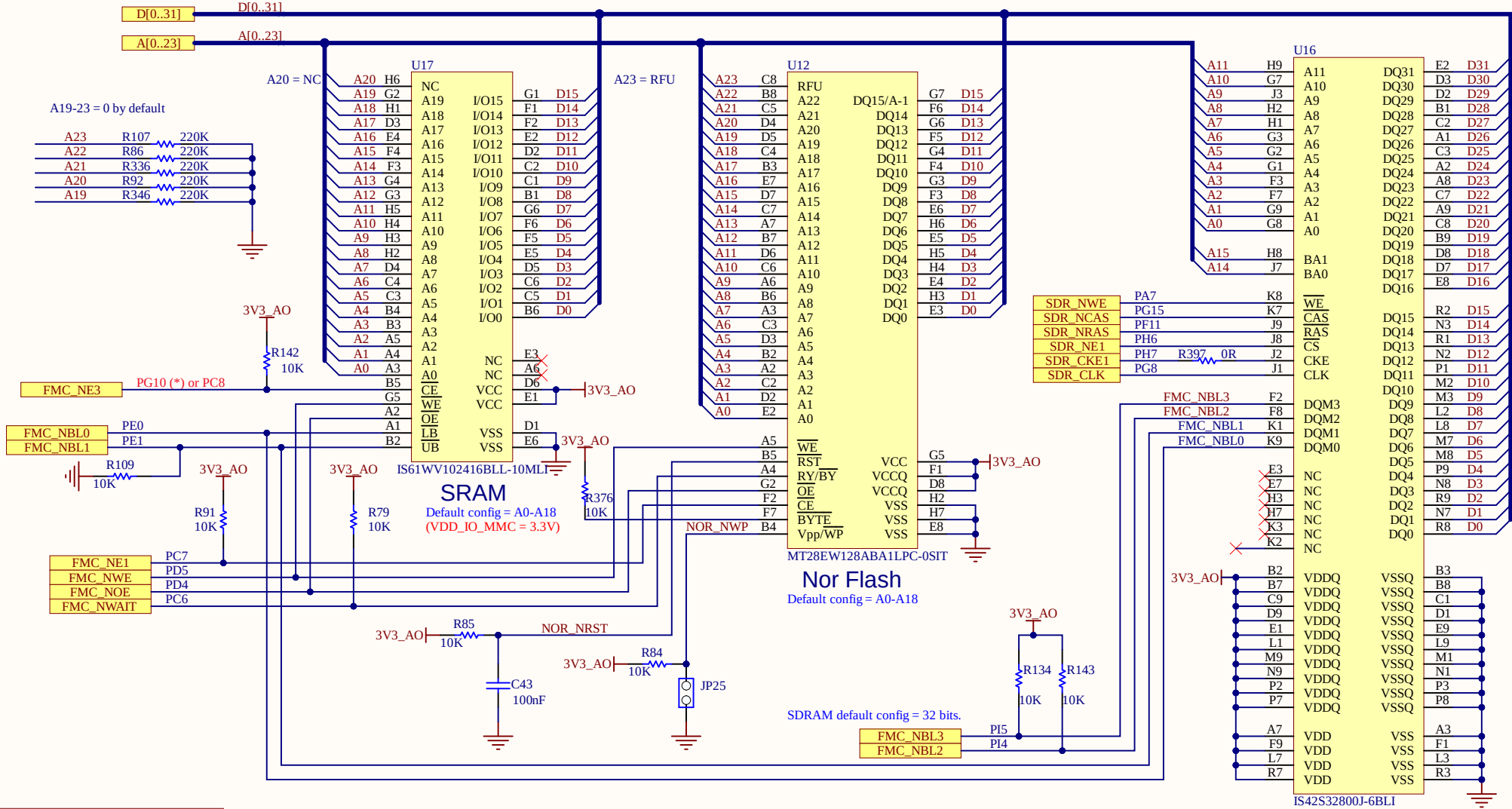
(Always $\overline{ON}$)



MEMORIES

(Always ON)

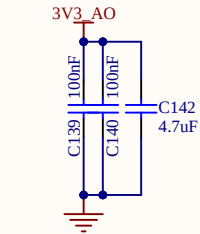
(*) Some SRAM I/Os are supplied by VDD_IO_MMC
(make sure to control MFX0 & PG6)
(see Power_Board page)



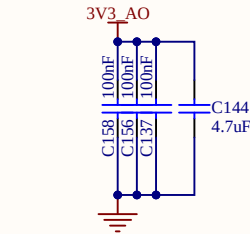
LIMITATIONS (SDRAM):
OCSPI2

LIMITATIONS (NOR):
CAMERA
OCSPI2, DFSDM DATIN3

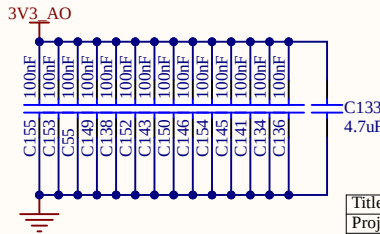
LIMITATIONS & BACK-UP (SRAM):
CAMERA
SD CARD : NE3 = PG10 (if SD CARD 1 is used) / PC8 (if SD CARD 2 is used)
OCSPI2
(*) Make sure to set VDD_IO_MMC = 3.3V



Place close to SRAM



Place close to Nor Flash



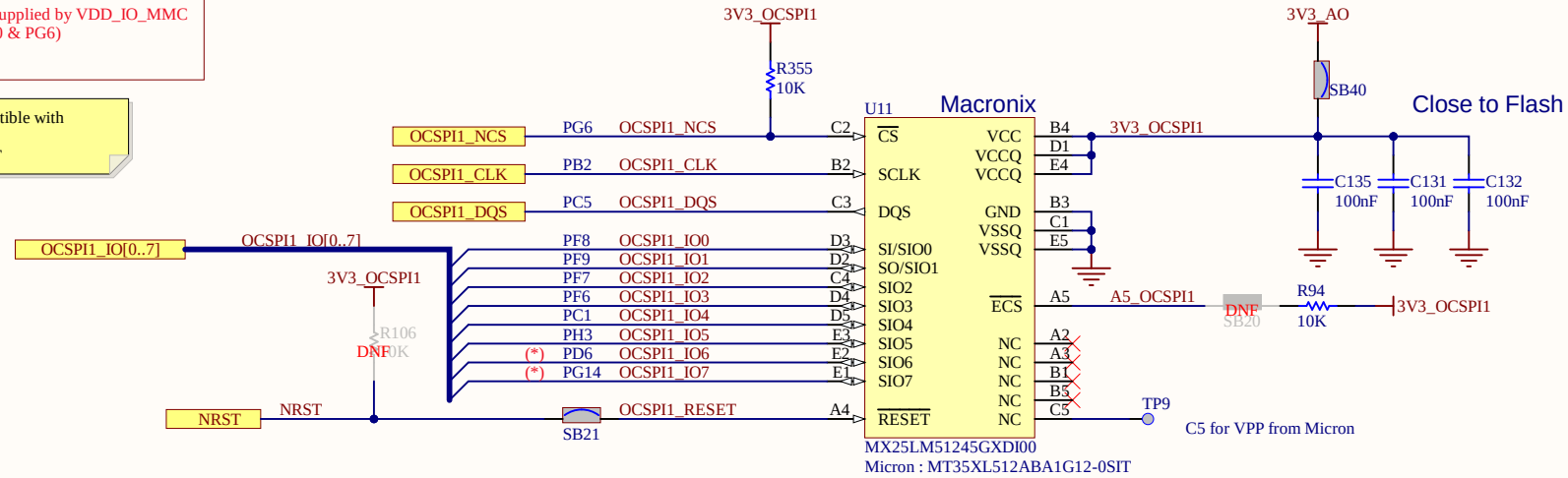
Place close to SDRAM



~~QCSP1 1~~

(*) Some OCSPI1 I/Os are supplied by VDD_IO_MMC
(make sure to control MFX0 & PG6)
(see Power_Board page)

Double footprint to be compatible with
Macronix and Micron
MT35XL512ABA1G12-0SIT



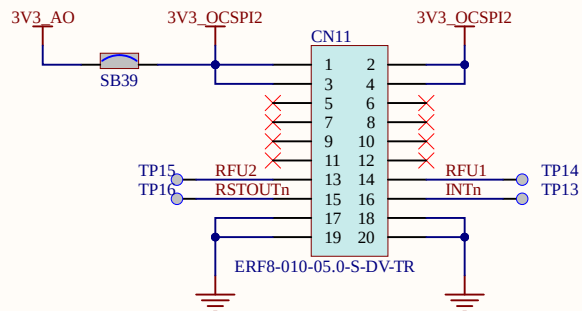
LIMITATIONS (see MCU page) :
SD CARD 2 (jumper)

(*) Make sure to set VDD_IO_MMC = 3.3V

(RESET pins of Flash have internal pull-up (both) by default and VPP connection is tbc on Micron)

OCSPI 2 (MB1242 Module connector)

(*) Some OCSPI2 I/Os are supplied by VDD_IO_MMC
(make sure to control MFX0 & PG6)
(see Power_Board page)



LIMITATIONS & BACK-UP (see MCU page):

FMC (NOR, SRAM & SDRAM)

SD CARD 2 (jumper)

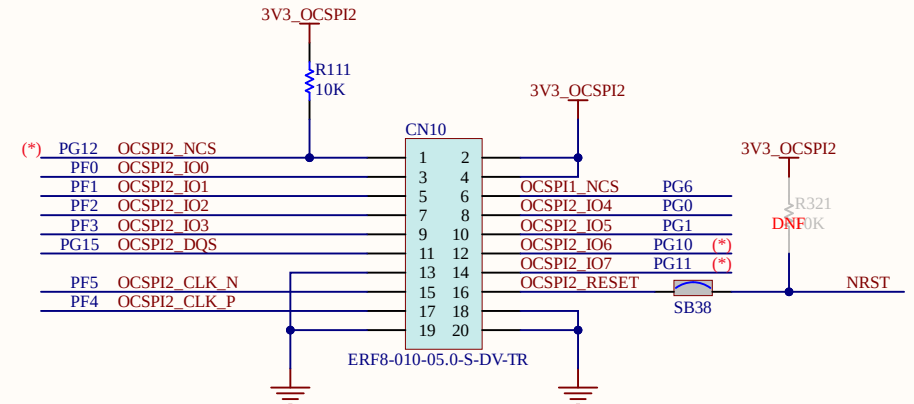
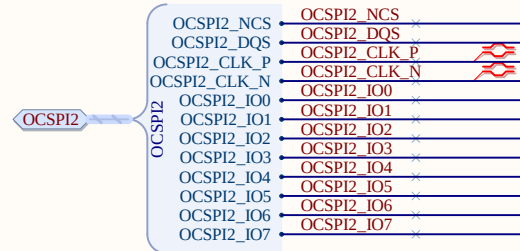
(*) Make sure to set VDD_IO_MMC = 3.3V

HW29

DNE

MB1242 - ERM8 BGA24 Octal SPI module

OCSPI2 (OPTIONAL)

Title: **OCSPI**Project: **STM32H7B3I-EVAL**Variant: [H7B3LIQ](#)

Revision: D-03

Reference: [MB1331](#)

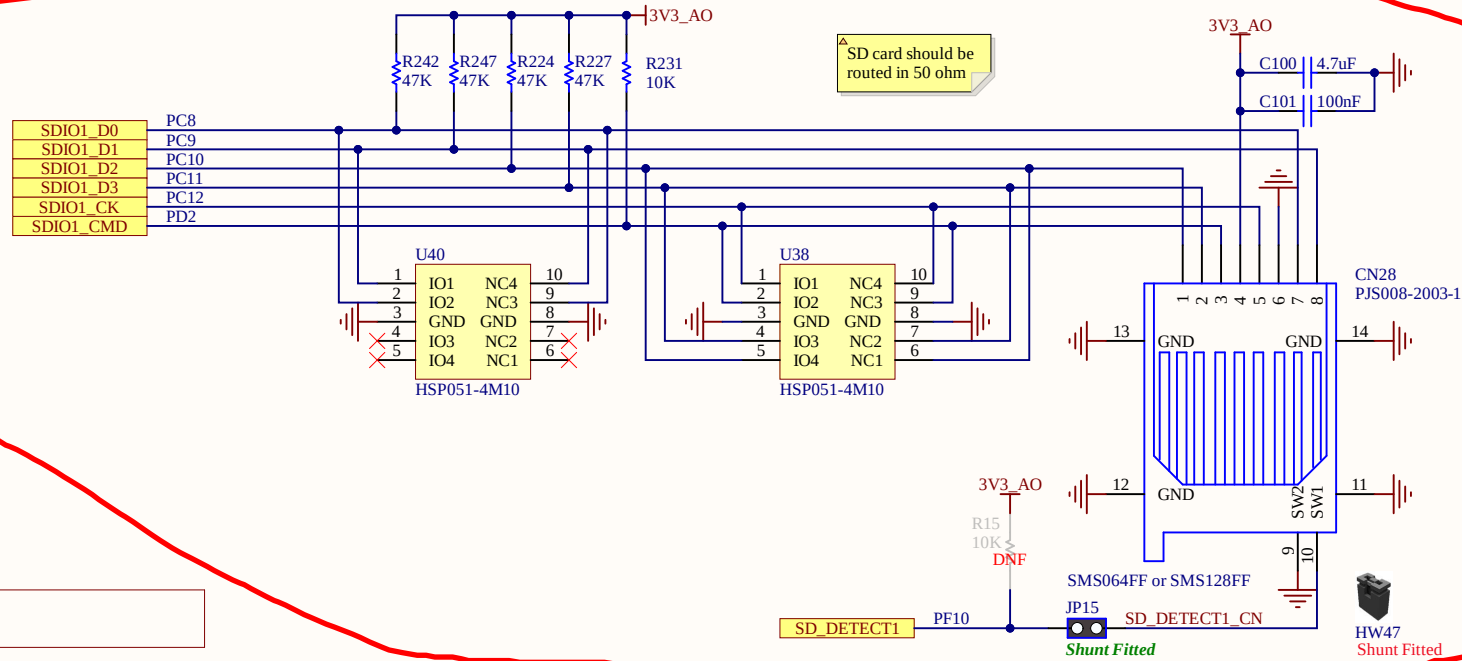
Size: A4

Date: 25-MAR-20

Sheet: 8 of 23

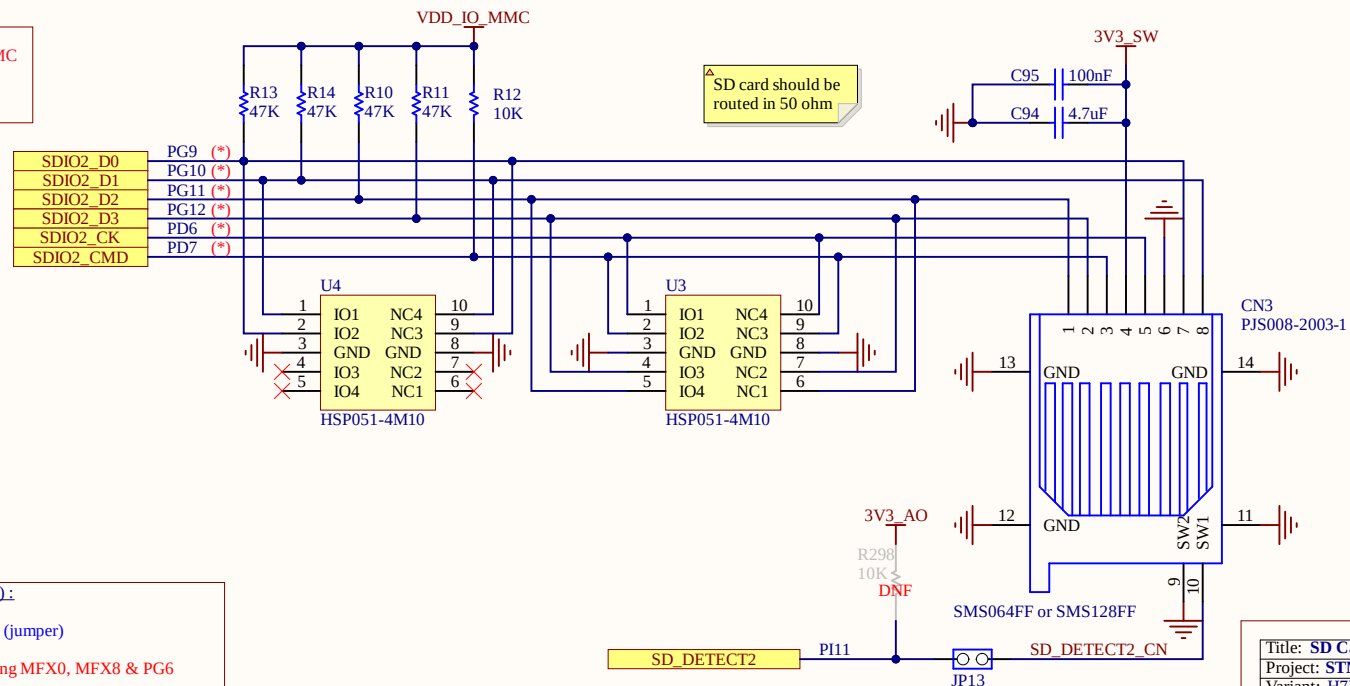


3V3 only
(Always ON)

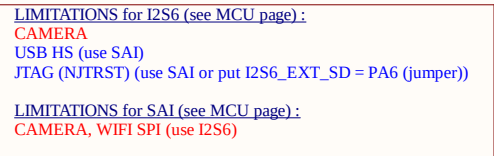


MICRO SD 3.0 Card 2

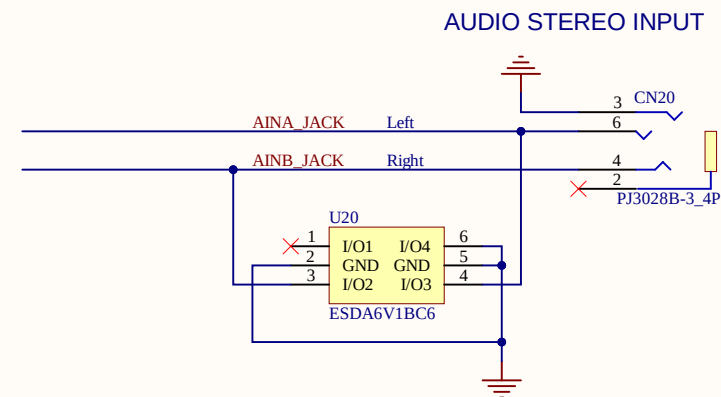
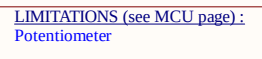
(*) SD CARD 2 is supplied by VDD_IO_MMC
(make sure to control MFX0, MFX8 & PG6)
(see Power_Board page)



(Always ON)

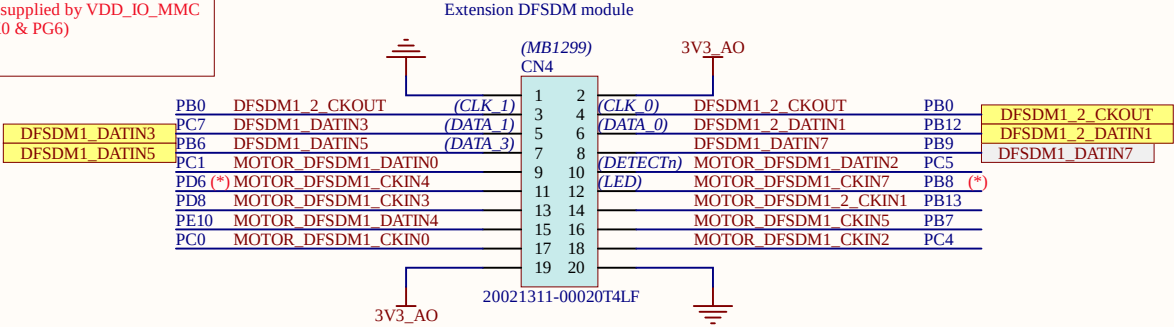


Close to MCU on PCB

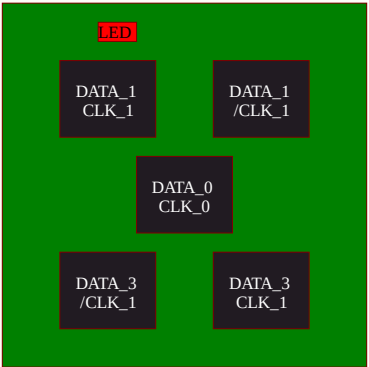


DFSDM AUDIO & MOTOR

(*) Some DFSDM I/Os are supplied by VDD_IO_MMC
(make sure to control MFX0 & PG6)
(see Power_Board page)



HW30
DNF
MB1299-5_MEMS_Microphone_Expansion_Board

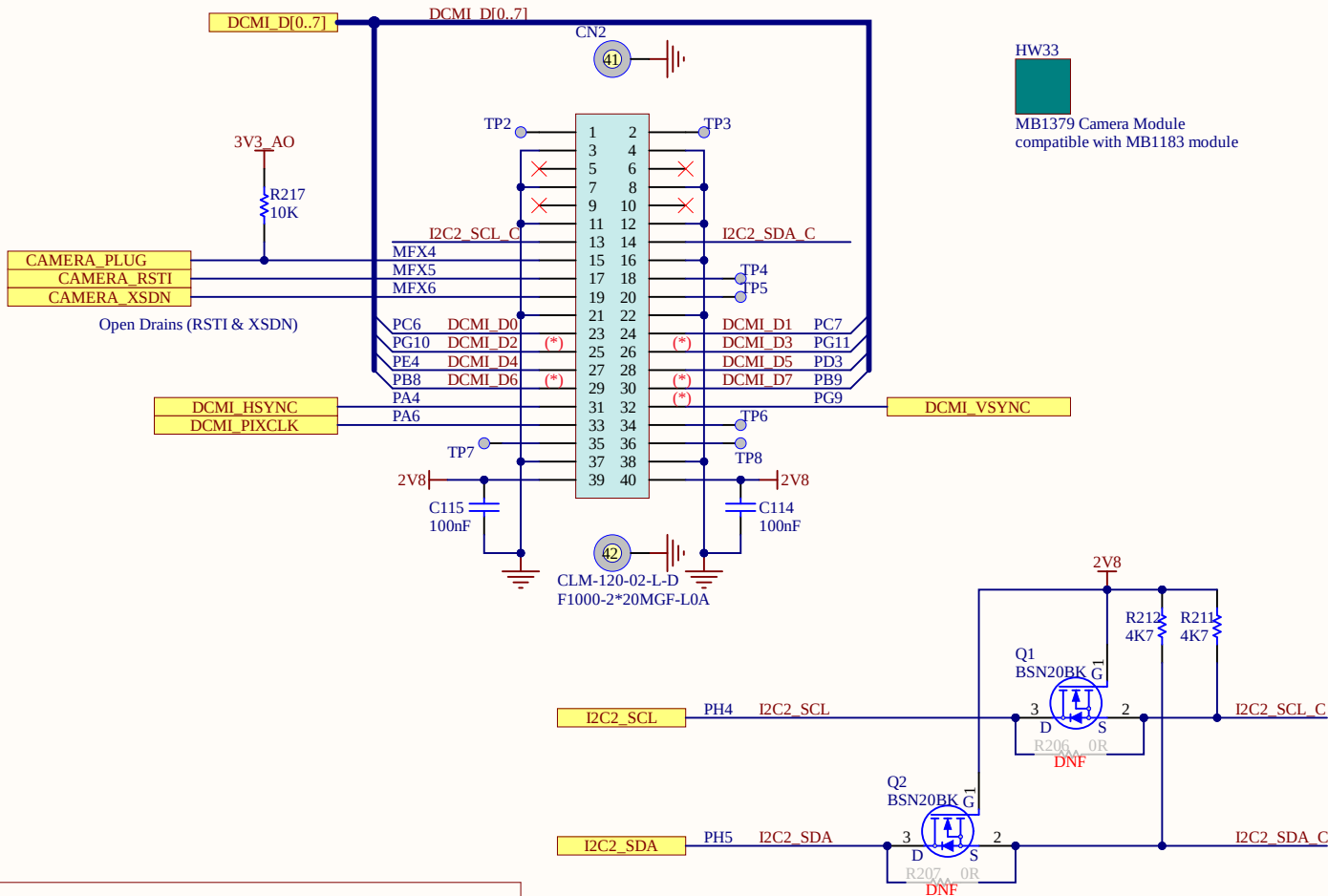


(MB1299)
CLK0 & CLK1 = data valid when clk is high
/CLK1 = data valid when clk is low

LIMITATIONS AUDIO DFSDMx4 (see MCU page):
(*) Make sure to set VDD_IO_MMC = 3.3V
CAMERA
USB HS, FMC NOR (jumper)

CAMERA MODULE CONNECTOR

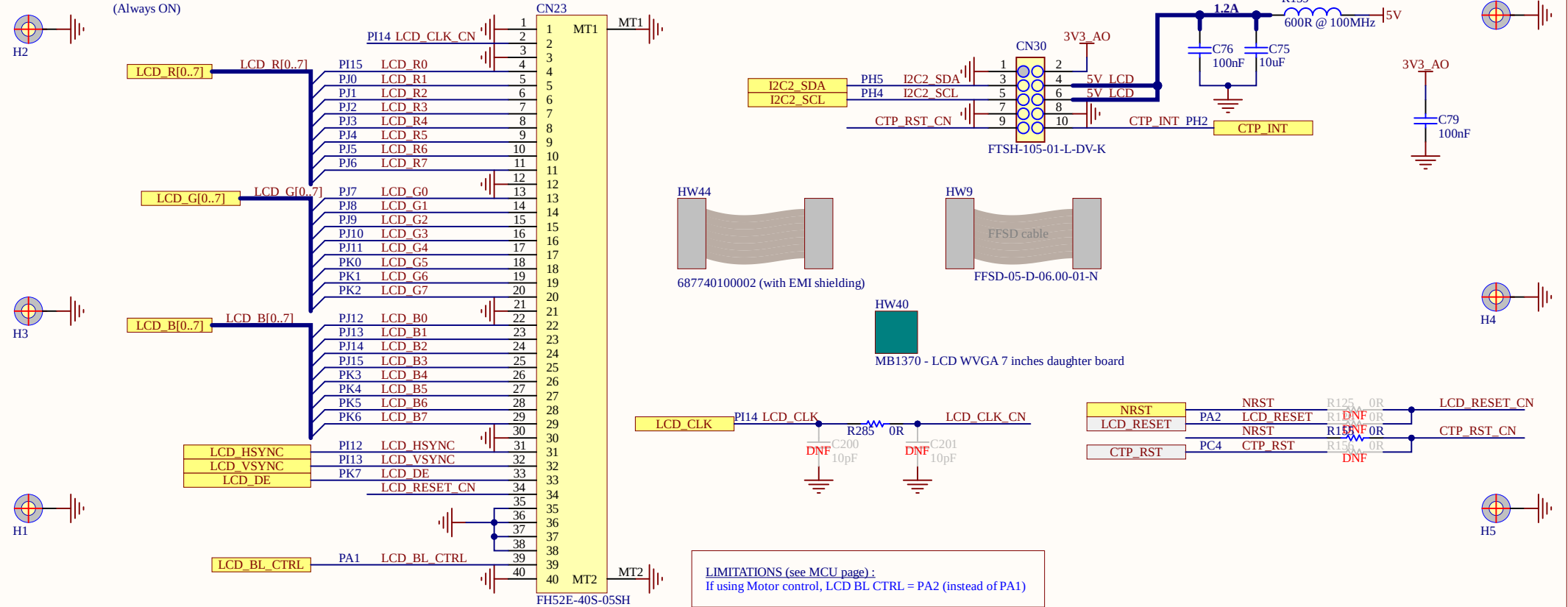
(*) Some DCM I/O are supplied by VDD_IO_MMC
(make sure to control MFX0 & PG6)
(see Power_Board page)



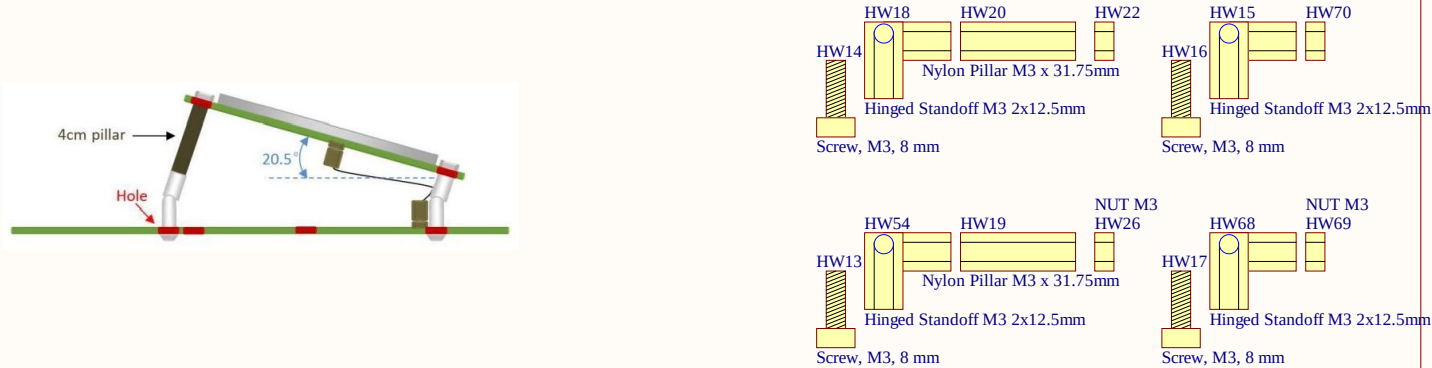
LIMITATIONS (see MCU page) :
AUDIO (I2S6), DFSDM
AUDIO (SAI), SRAM, NOR, SD CARD 2, OCSPI2
(*) Make sure to set VDD_IO_MMC = 3.3V



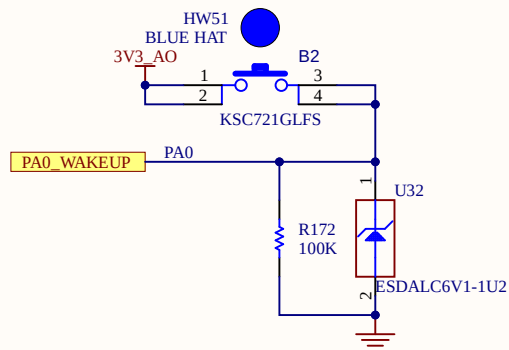
RGB LCD MODULE CONNECTORS



LCD MODULE MECHANICAL ASSEMBLY

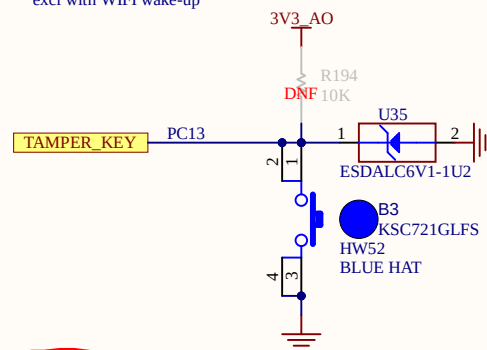


USER WAKE-UP BUTTON

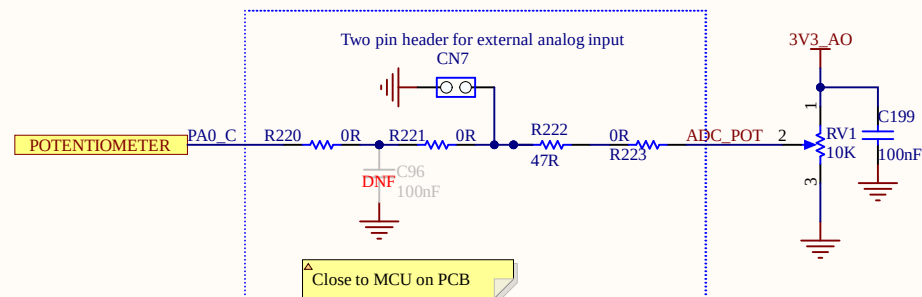


TAMPER & KEY BUTTON

excl with WIFI wake-up

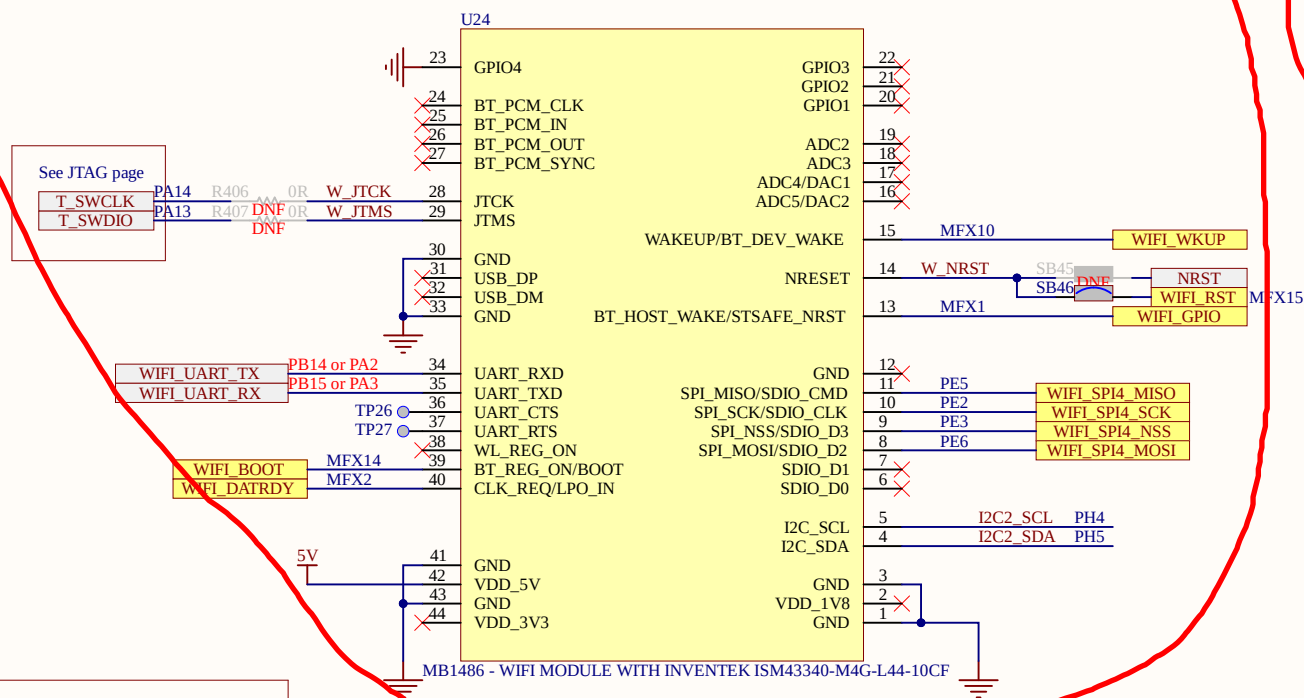


POTENTIOMETER



MB1486 - WIFI MODULE WITH INVENTEK ISM43340-M4G-L44-10CF

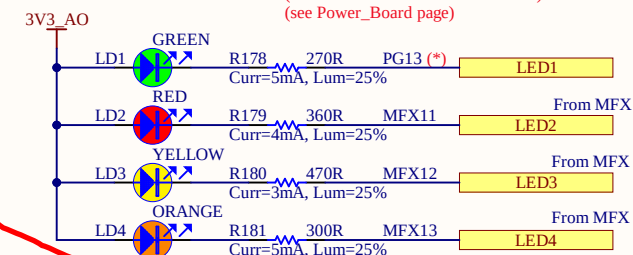
(WIFI SPI by default)
(Always ON)



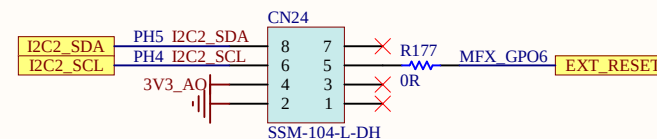
LIMITATIONS (see MCU page):
EXT I2C

LEDs

(*) LED1 I/O is supplied by VDD_IO_MMC
(make sure to control MFX0 & PG6)
(see Power_Board page)

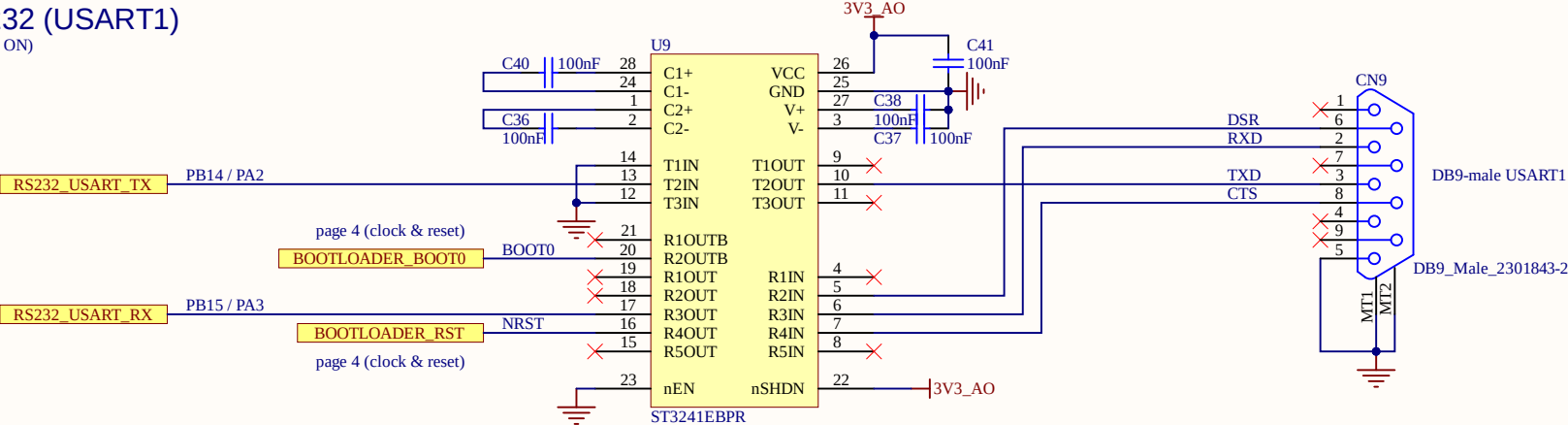


EXT_I2C



LIMITATIONS (see MCU page):
WIFI

RS232 (USART1)
(Always ON)

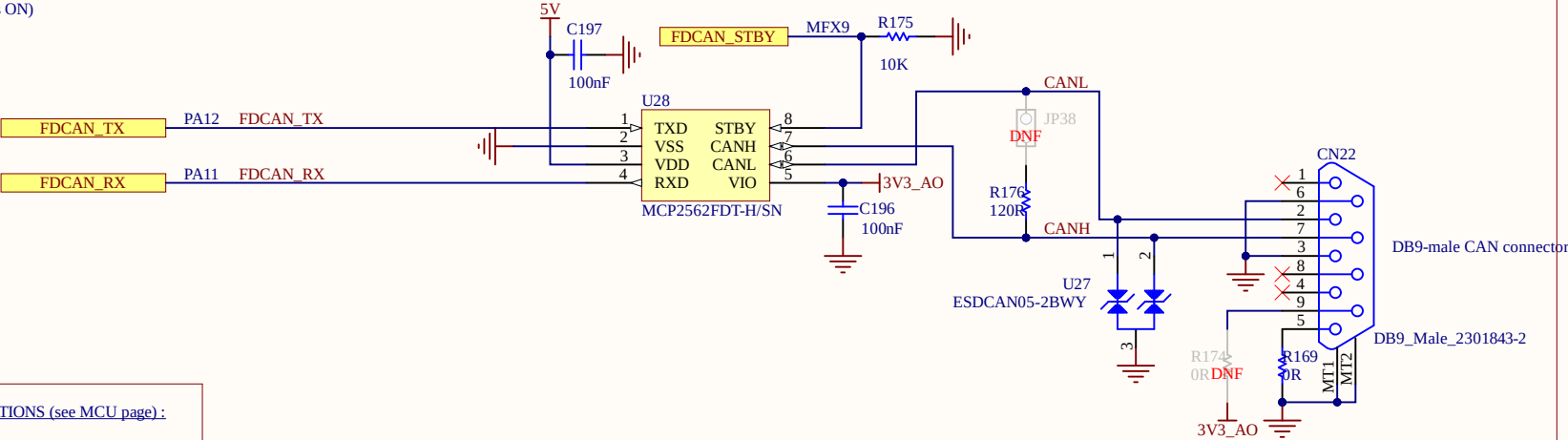


LIMITATIONS (see MCU page) :

PB14/PB15 : not a bootloader compatible UART

PA2/PA3 : AUDIO I2S6, USB HS, MOTOR CONTROL

CAN FD
(optional ; not fitted)
(Always ON)



LIMITATIONS (see MCU page) :

USB FS



(optional : not fitted)

external generator input : pins 1 and 3
voltage of complex load : pins 2 and 3
shunt voltage : pins 1 and 2

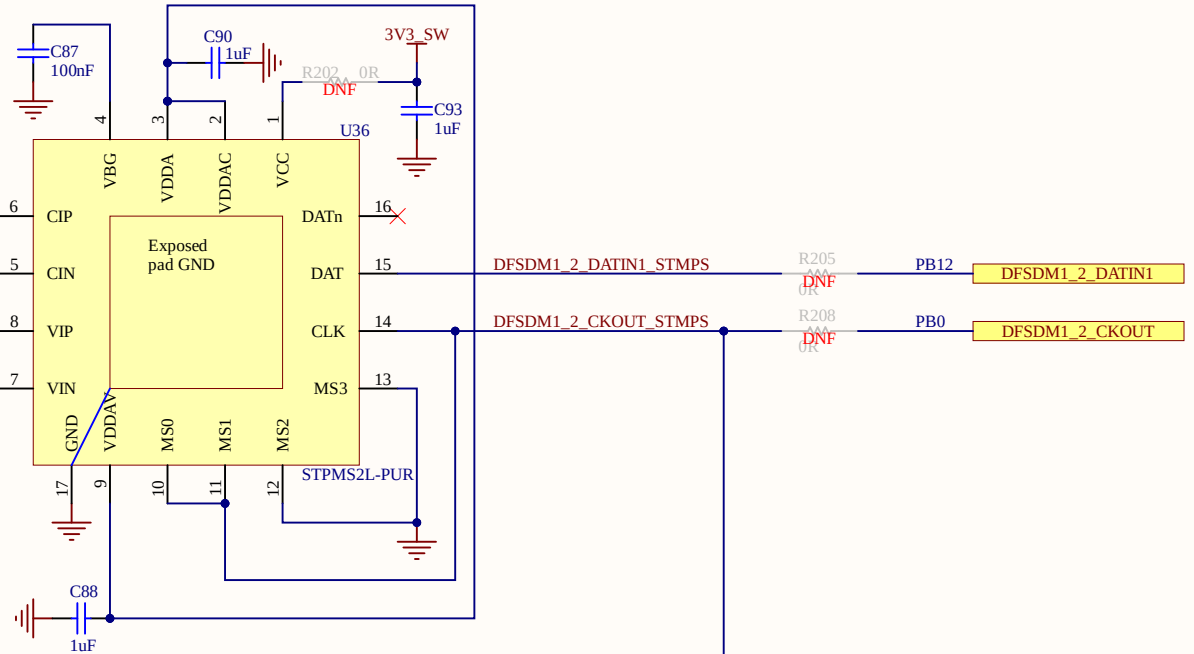
current shunt

R197 1K

C86 4.7uF

R198 1K

R+jX Load



See user manual

(optional : not fitted)

The schematic diagram illustrates the DFSDM1 module configuration on the STM32H7B3I-EVAL board. The microcontroller (U37) is shown with its pins connected to various components. The DFSDM1 module is configured with DATIN5 and CKOUT5. The output of CKOUT5 is connected to PB6. The diagram also shows the power supply connections for VBG, VDDA, VDDAC, VCC, and VIN. The current shunt is connected to the VIN pin. The output of CKOUT5 is connected to PB6. The diagram also shows the power supply connections for VBG, VDDA, VDDAC, VCC, and VIN.

Title:	STMP2S2LPT100
Project:	STM32H7B3I-EVAL
Variant:	H7B3LIO

See user manual

Title: STMP2&PT100		
Project: STM32H7B3I-EVAL		
Variant: H7B3LIQ		
Revision: D-03		Reference: MB1331
Size: A4	Date: 25-MAR-20	Sheet: 16 of 23



MOTOR CONTROL
(optional : not fitted)

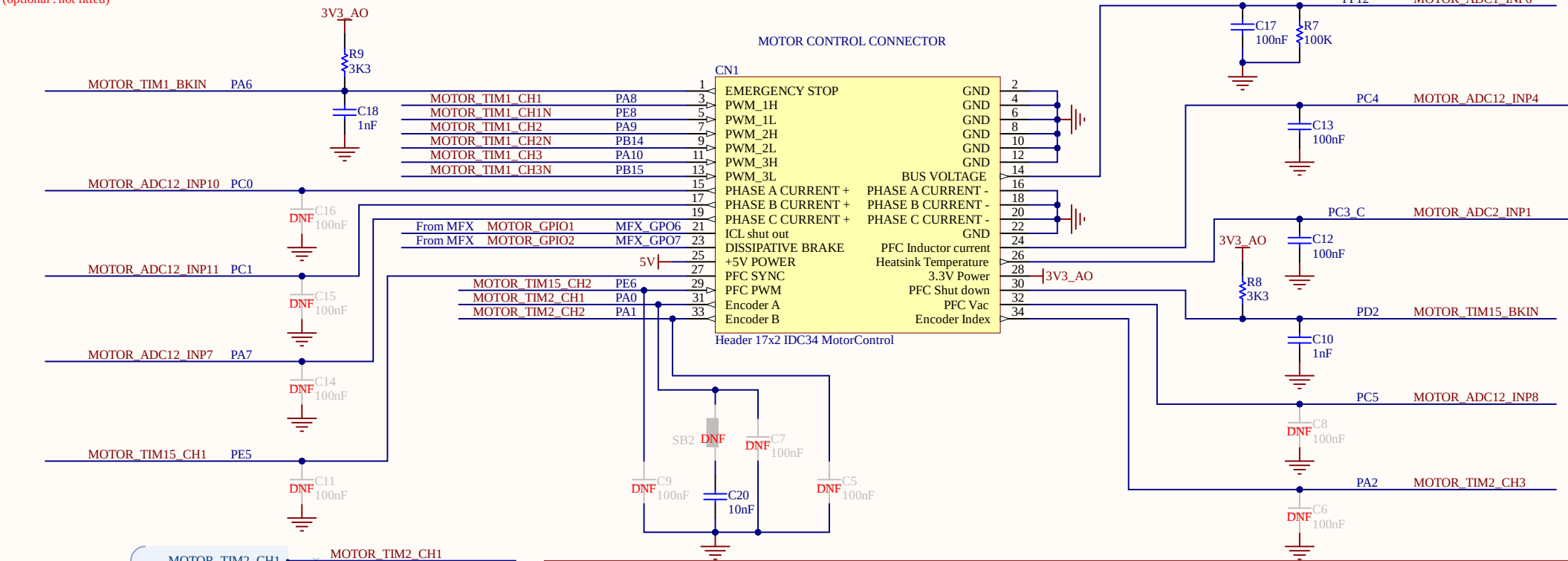
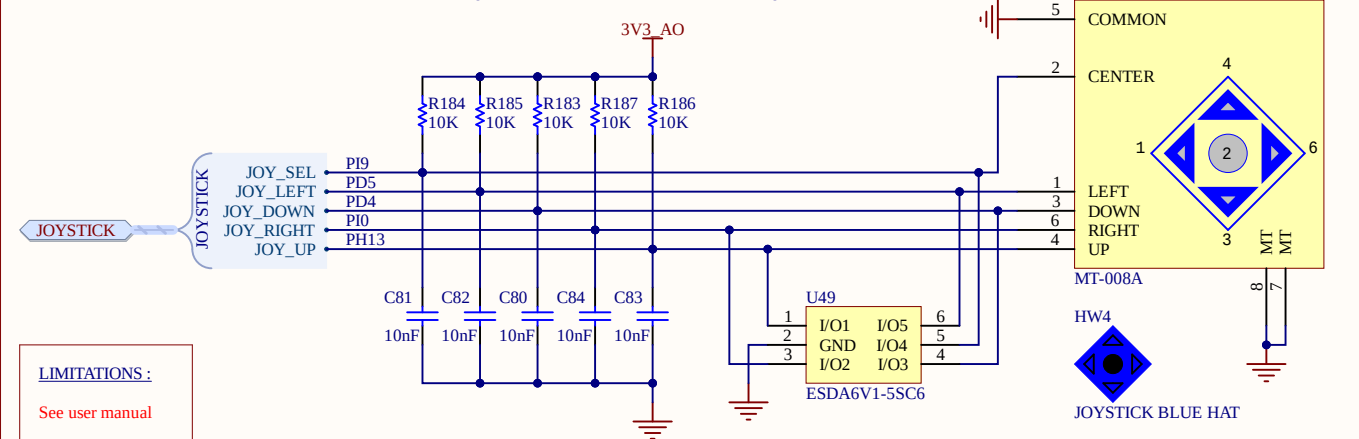


Table mapping MOTOR pins to MOTOR control signals. Includes pins like MOTOR_TIM1_BKIN, MOTOR_TIM1_CH1, MOTOR_TIM1_CH1N, etc., and their corresponding control signals.

LIMITATIONS :
See user manual

MOTOR CONTROL JOYSTICK (OPTIONAL : not fitted)

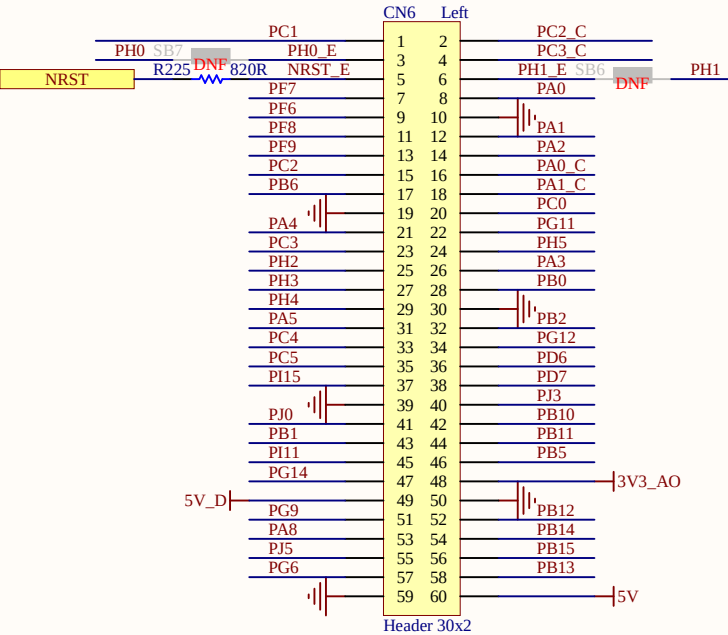


LIMITATIONS :
See user manual

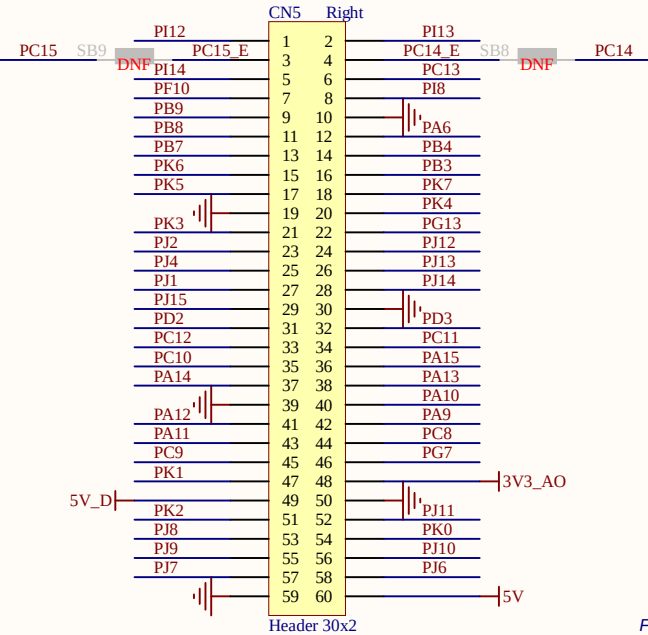
(Always ON)



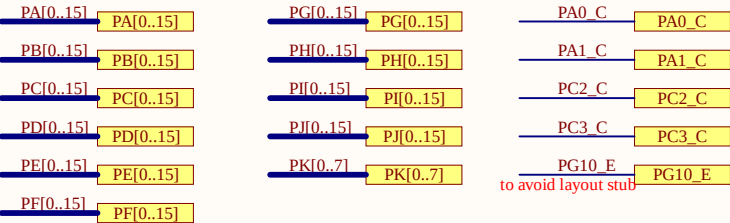
MCU EXTENSION CONNECTORS



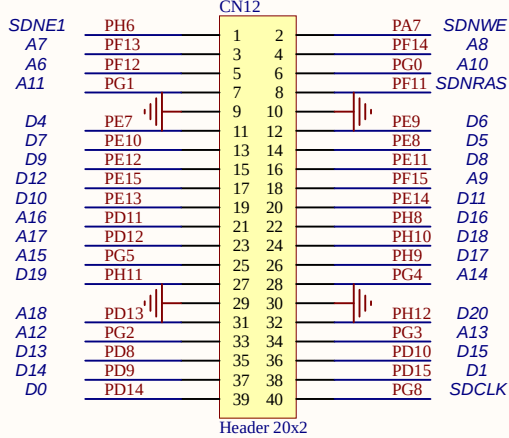
FTR-130-03-L-D-LC (Samtec)
or FTR-130-53-L-D-LC (Samtec) ?



FTR-130-03-L-D-LC (Samtec)
or FTR-130-53-L-D-LC (Samtec) ?

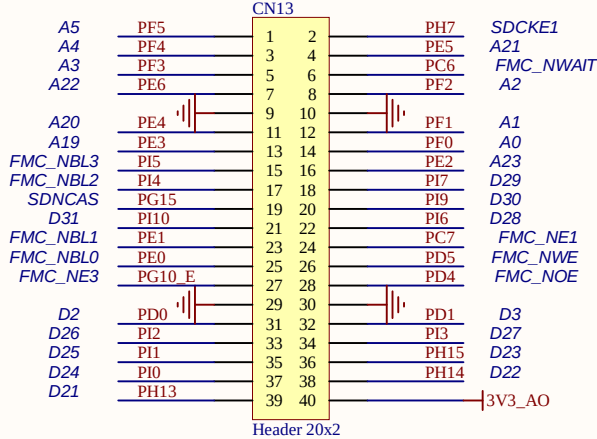


Place close Memory



FTR-120-03-L-D-LC (Samtec)
or FTR-120-53-L-D-LC (Samtec) ?

Place close Memory



FTR-120-03-L-D-LC (Samtec)
or FTR-120-53-L-D-LC (Samtec) ?



5V Power Supply options

JP29

5V_STLK

5V_EXT

5V_USB_HS

5V_USB_FS

5V_D

5V_USB_CHGR

Shunt Fitted 3-4

HW55

5V

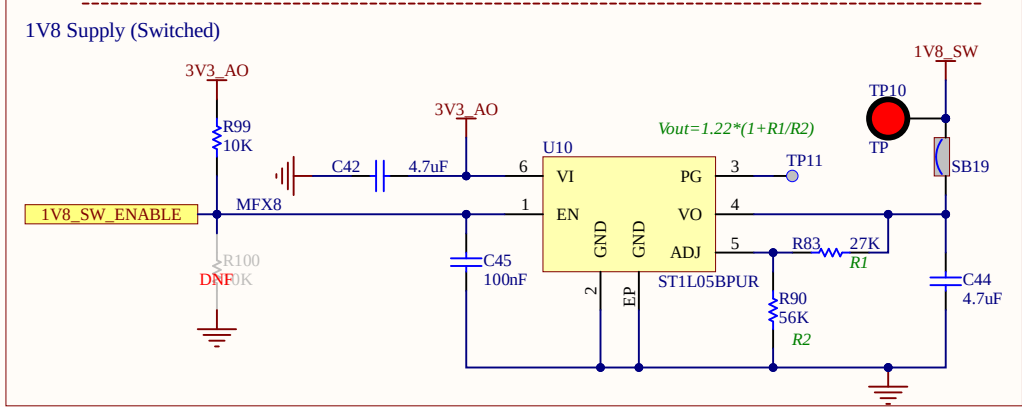
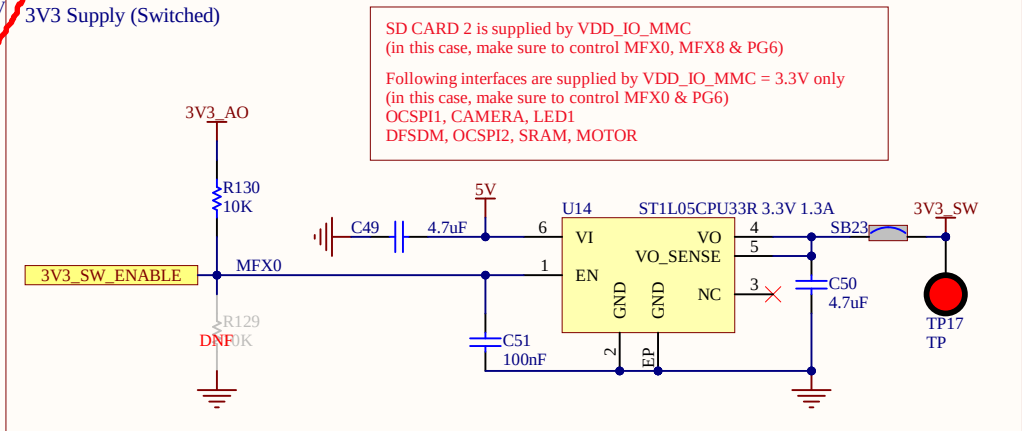
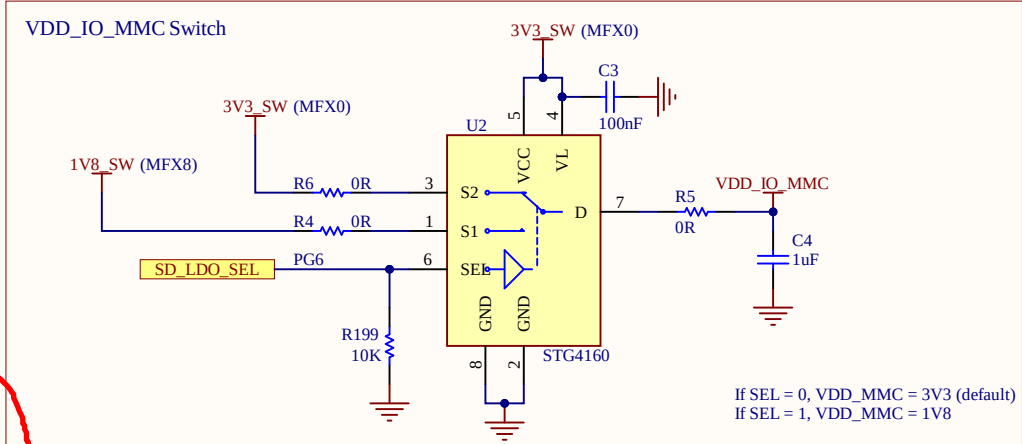
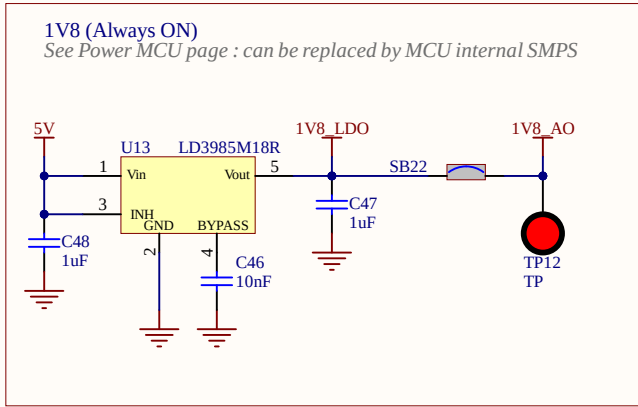
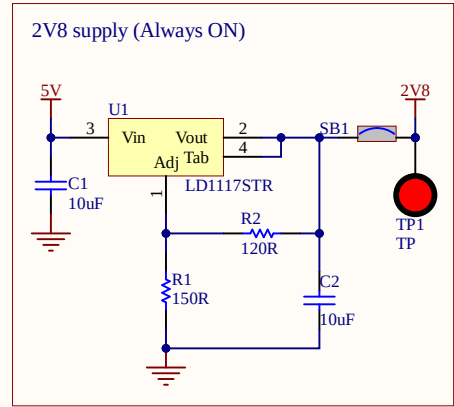
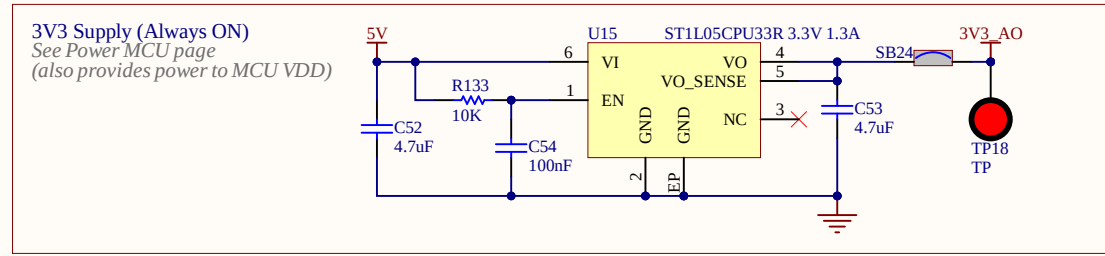
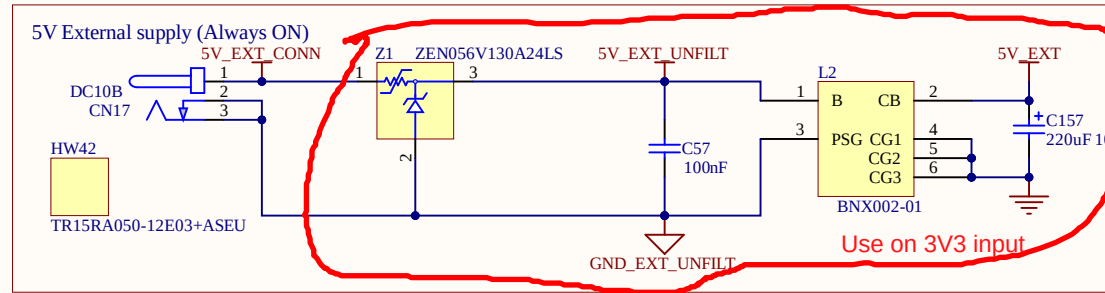
R112

620R

LD7

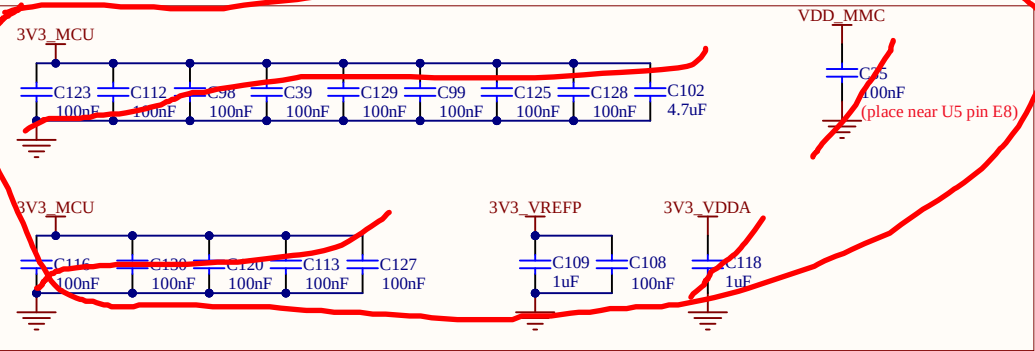
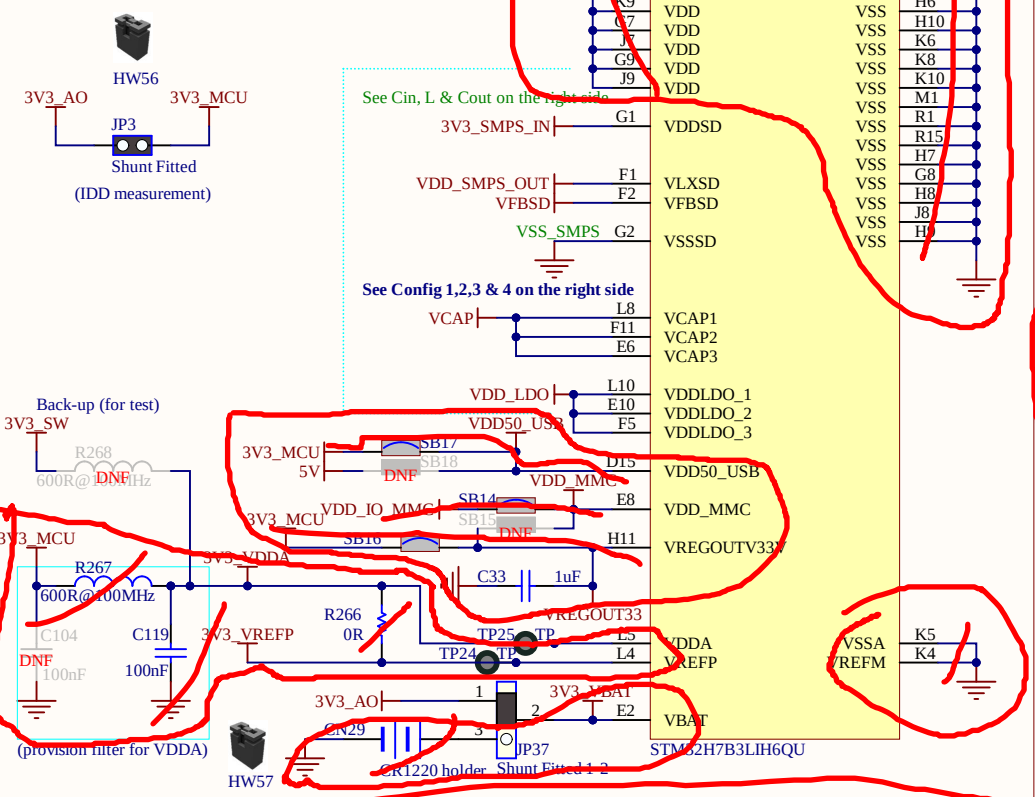
Curr=5mA, Lum=25%

GREEN



MCU POWER

STM32H7B3LIH6Q Power



Internal LDO/SMPS Supply Configuration

For further details, please see UM2662 User Manual and RM0455 STM32H7A3 Reference Manual

Supply Config 1 : LDO only (SMPS OFF, LDO ON)

3V3_MCU, VDD_LDO, VFBS, R251, 3V3_SMPS_IN, SB10, 2x2.2uF instead of 2x100nF near VCAP pins / plan

Disconnect 3V3_SMPS_IN from 3V3_MCU
Connect 3V3_SMPS_IN to GND
Connect VDD_SMPS_IND_OUT to GND
Connect VDD_LDO to 3V3_MCU
2 x 2.2uF near VCAP pins/pins

1. LDO supply

Supply Config 2 : SMPS only (SMPS ON, LDO OFF)

Default config

VDDSD G1, F1, 3V3_MCU, 3V3_SMPS_IN, VDD_SMPS_OUT, VDD_SMPS_IND_OUT, VCAP, VSS_SMPS, C28, C29, C21, C26, SB5, C24, C27, C25, C23, C22, C21, C20, C19, C18, C17, C16, C15, C14, C13, C12, C11, C10, C9, C8, C7, C6, C5, C4, C3, C2, C1, C0

2. Direct SMPS supply

Supply Config 3 : SMPS & LDO cascaded (SMPS & LDO ON)

VDD_LDO, R262, VFBS, 2x100nF near VDDLDO pins / plan

Compared to config 2 :
Disconnect VDD_SMPS_IND_OUT from VCAP1/2/3
Connect VDD_SMPS_IND_OUT to VDD_LDO
Add 2x100nF near VDDLDO pins/plans
Add 2x2.2uF near VCAP pins/plans (see config 1)

3. SMPS supplies LDO (no external supply)

Supply Config 4 : same as config 3, but SMPS supplies also 1V8 to board

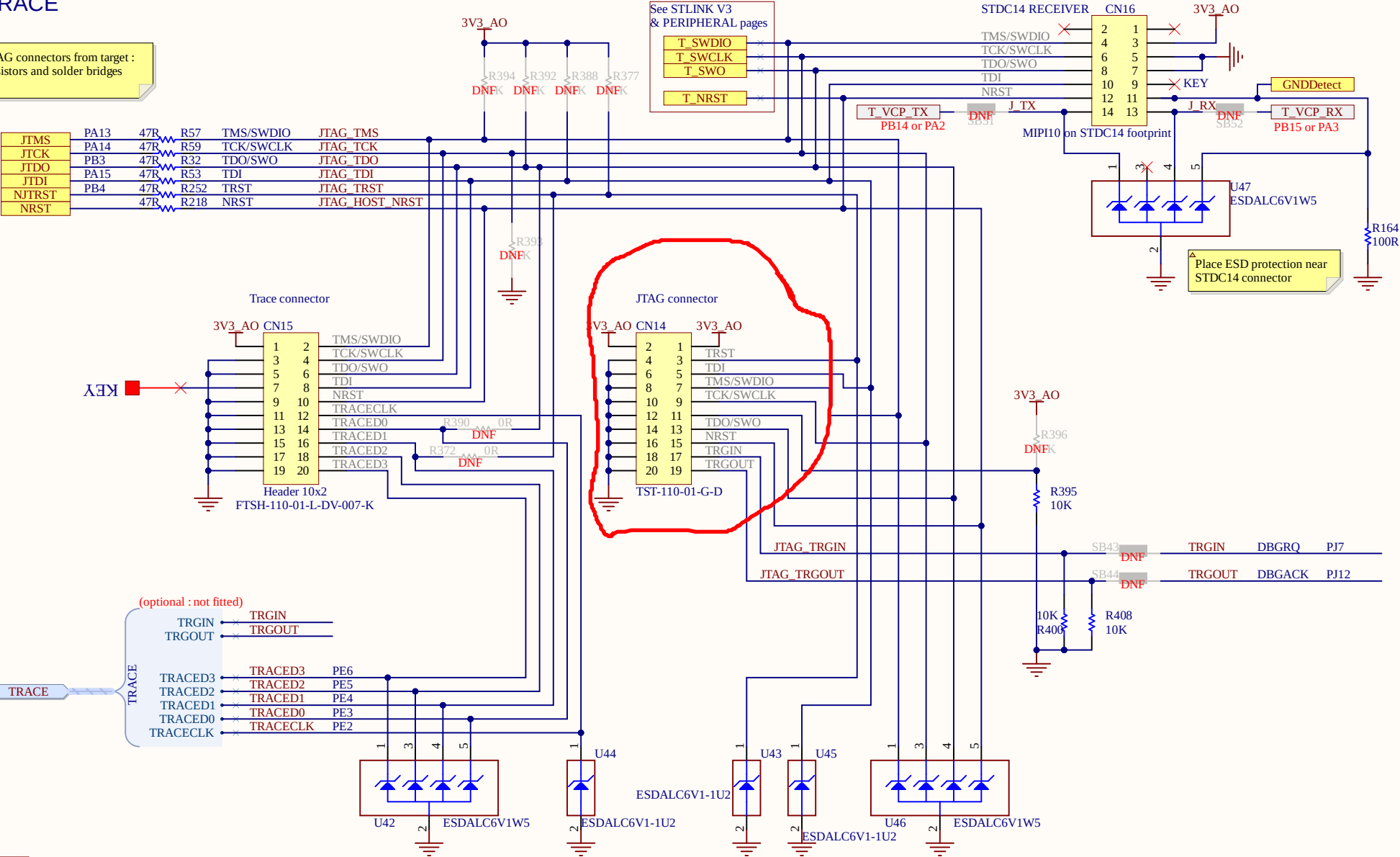
VDD_SMPS_IND_OUT, SB4, DNF, 1V8_AO, C21, 4.7uF

Compared to config 3
Connect VDD_SMPS_IND_OUT to 1V8 board supply
Add a 10uF close to the 1.8V board supply
Add a 10uF close to one VDD_LDO pin

4. External SMPS supply, supplies LDO

JTAG & TRACE
(Always ON)

To disconnect JTAG connectors from target :
- Remove 47R resistors and solder bridges

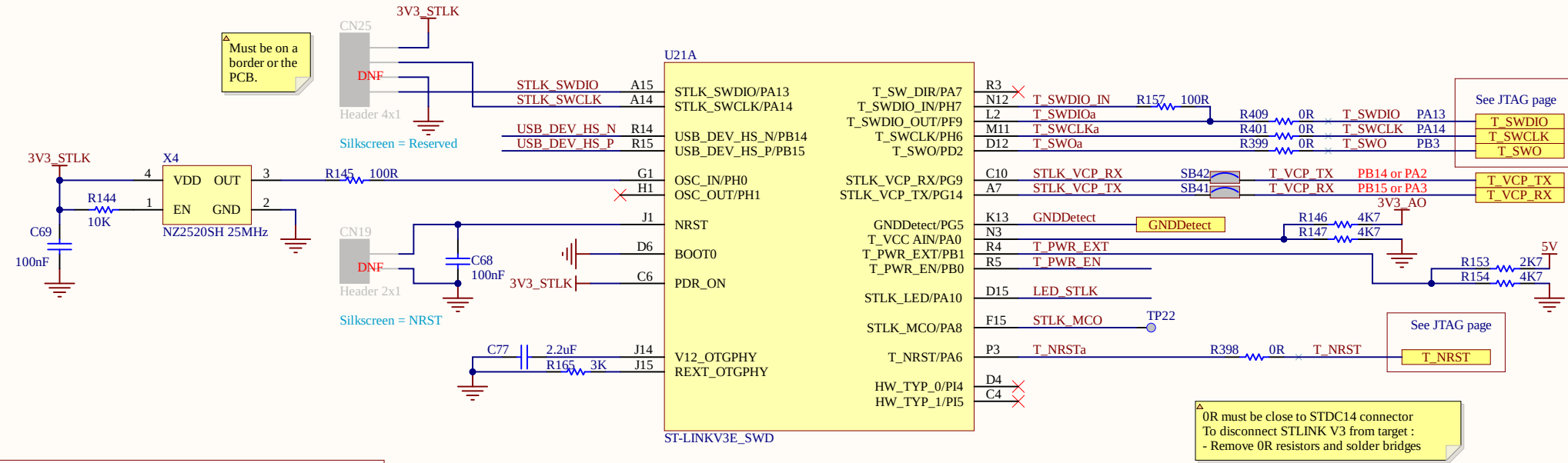


LIMITATIONS :
see User Manual



STLINK V3E SWD
(Always ON)

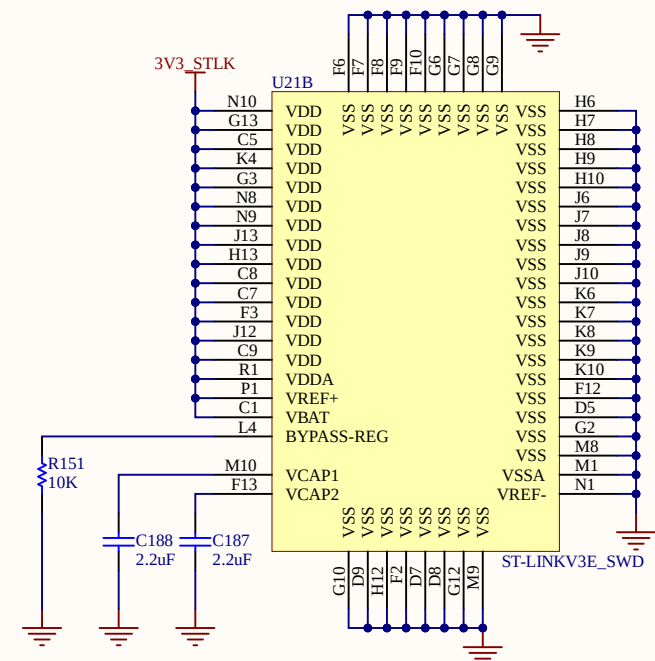
STLINK V3E



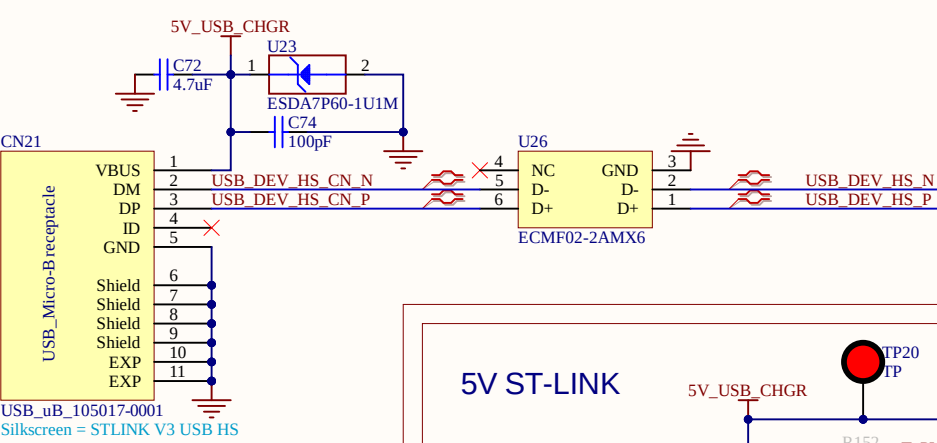
LIMITATIONS (see MCU page):

Back up : if SD CARD 2, use UART VCOM back-up (PB14/PB15)

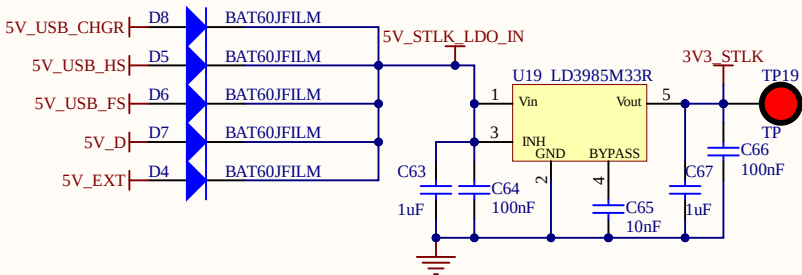
POWER



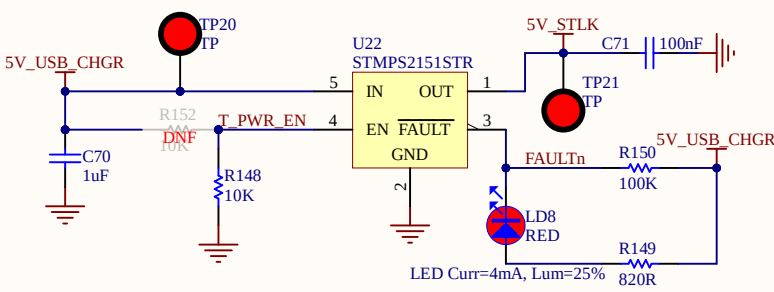
STLINK USB HS & 5V USB CHARGER



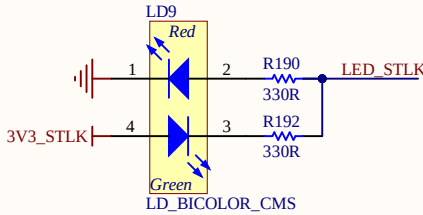
3.3V ST-LINK

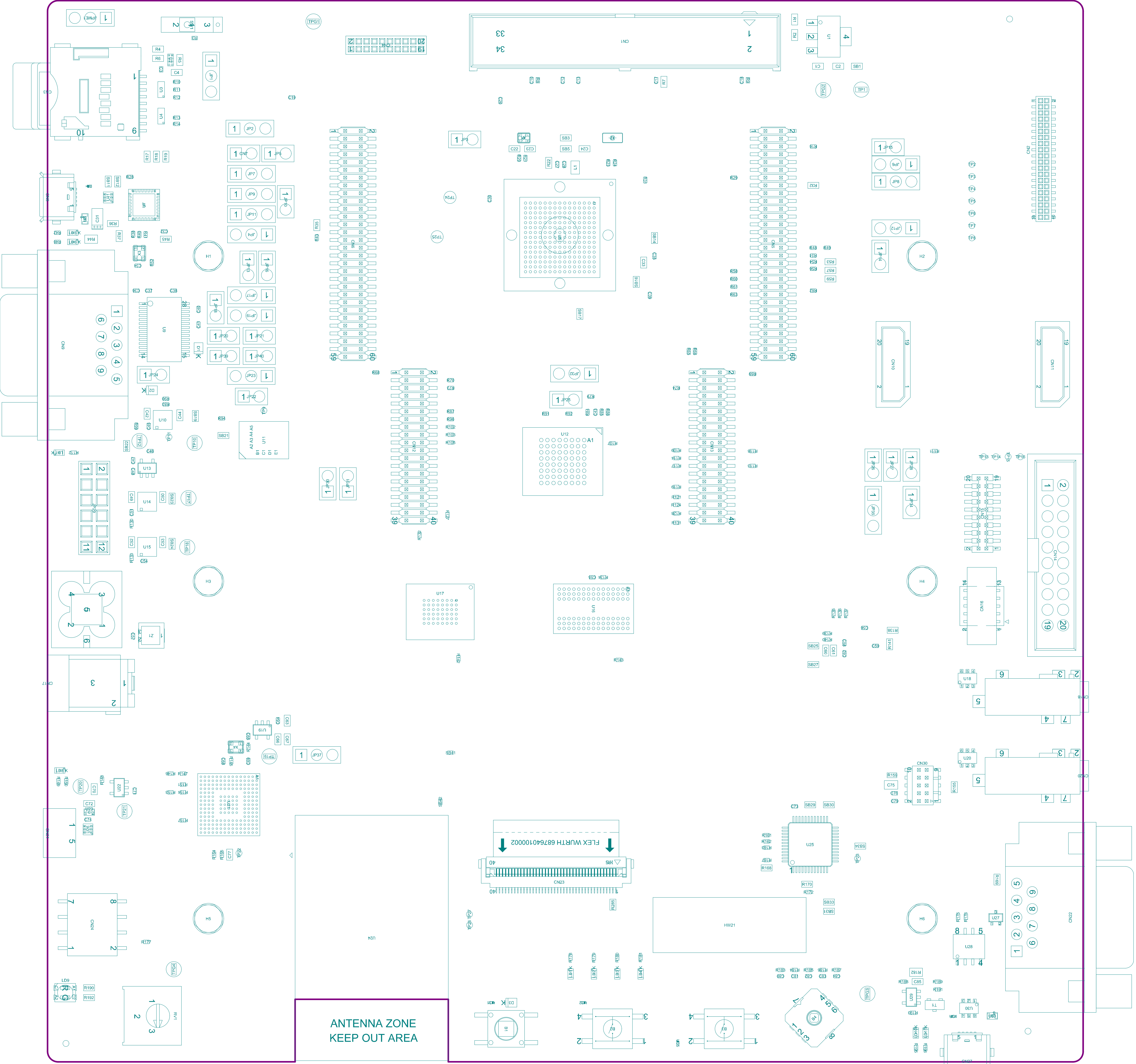


5V ST-LINK



LED





Project: STM32H7B3I-EVAL

Layer: M14-Top Assembly

Variant: H7B3LIQ

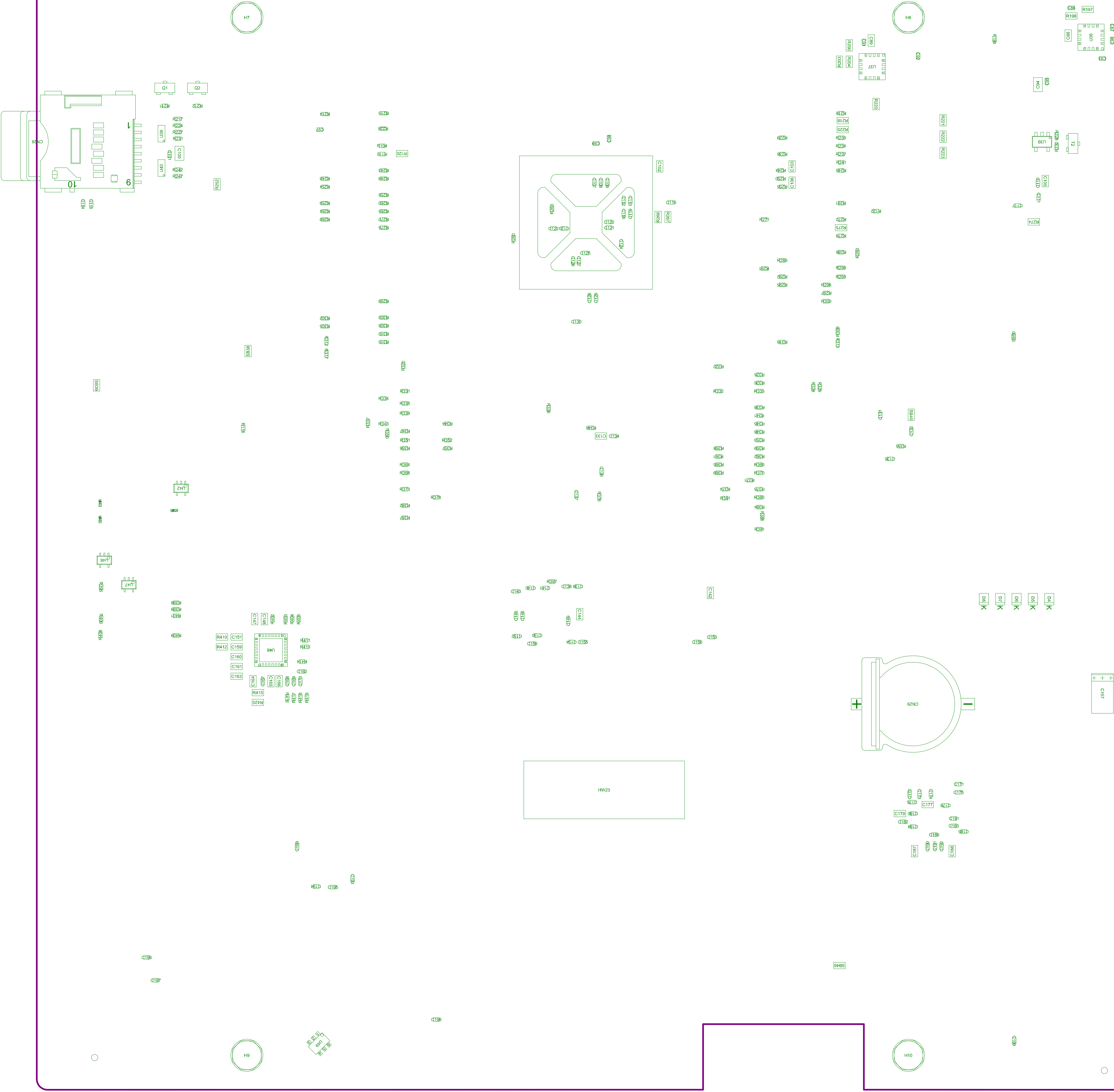
Date: 25-MAR-20

Gerber: .GM14

Ref: MB1331

Rev: D





Project: STM32H7B3I-EVAL		
Layer: M15-Bottom Assembly	Gerber:.GM15	
Variant: H7B3LIQ	Ref: MB1331	
Date: 25-MAR-20	Rev: D	